

M306V0T-RPD-E

Emulation Pod for M16C/6V Group M306V0

User's Manual

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For inquiries about the contents of this document or product, fill in the text file the installer of the emulator debugger generates in the following directory and email to your local distributor.

\SUPPORT\Product-name\SUPPORT.TXT

Renesas Tools Homepage http://www.renesas.com/en/tools

(2/48)

Preface

The M306V0T-RPD-E is an emulation pod for the M16C/6V group of Renesas 16-bit MCUs. The M306V0T-RPD-E is used by being connected to the PC4701 emulator (PC4701HS, PC4701L, PC4700H or PC4700L) and is controlled by the emulator debugger.

This manual mainly explains specifications and setting up of the M306V0T-RPD-E. For detail information about the PC4701 emulator and the emulator debugger, refer to each user's manual.

To check the components of this product, refer to "Things to Check When Unpacking" in this manual. If there is any question or doubt about this product, contact your local distributor.

To use the product properly

Precautions for Safety



• In both this user's manual and on the product itself, several icons are used to insure proper handling of this product and also to prevent injuries to you or other persons, or damage to your properties.

• The icons' graphic images and meanings are given in "Chapter 1. Precautions for Safety". Be sure to read this chapter before using the product.

When using outside Japan



• When using in Europe, the United States, or Canada, be sure to use both the emulator and the emulation pod which meet local standards. EMI standards are not met when this product is used with the PC4700H or PC4700L emulator.

(3/48)

Contents

Terminolog	у6
Things to C	heck When Unpacking7
Chapter 1. I	Precautions for Safety
1.1 \$	Safety Symbols and Meanings
1.2 H	Precautions for Safety9
Warning	Warning for Installation9
	Warning for Use Environment9
Caution	Cautions to Be Taken for This Product9
	Caution for Installation9
Important	Notes on PC4701 Emulators10
	Notes on Abnormal Operation10
	Notes on Target System10
	Notes on Connecting Target System11
	Note on Reset Input from Target System11
	Note on HOLD Input from Target System11
	Note on Address 0 Access11
	Notes on Differences between Actual MCU and Emulator
	Notes on MAP Settings and References14
	Note on Changing Data in OSD RAM Area When Program is not Executed14
	Note on Reading MCU Internal Sources15
	Note on Stack
Chapter 2. I	Introduction
Chapter 3. S	Specifications17
Chapter 4. S	Settings for Target Systems
4.1 H	Positions of Switches
4.2 \$	Settings
4.3 H	Procedure for Setting Oscillation Frequency
4.4 I	Data Slicer I/O Signals and OSD Clock I/O Signal Circuits23
4.5 H	Procedure for Setting Switches
4.6 H	Procedure for Writing MCU File

(4/48)

Chapter 5. Method of Connection
5.1 Connecting Emulator Main Unit26
5.2 Connecting Target System
Chapter 6. Constraints
Chapter 7. Operation Timing (Memory Expansion and Microprocessor Modes)
7.1 Separate Bus (no wait)
7.2 Separate Bus (with wait), When Accessing to External Memory Area
7.3 Multiplex Bus (with wait), When Accessing to External Memory Area
7.4 Timing Requirements
Chapter 8. Electrical Characteristics
Chapter 9. Maintenance and Guarantee
9.1 Maintenance40
9.2 Guarantee40
9.3 Repair Provisions40
9.4 How to Request for Repair41
Chapter 10. Troubleshooting
10.1 When M306V0T-RPD-E Does Not Work Properly42
Appendix A. External Dimensions
A.1 External Dimensions of the M306V0T-RPD-E43
A.2 External Dimensions of the FLX-100LCC44
Appendix B. Connection Diagrams

Terminology

Some specific words used in this User's Manual are defined as follows:

PC4701

This means the generic name of the PC4701HS, PC4701L, PC4700H, and PC4700L emulators.

PC4701 system

This means an emulator system built around a PC4701 emulator. The PC4701 emulator system is configured with the emulator main unit, an emulation pod, an emulator debugger, and a host machine.

Emulator debugger

This means a software tool to control the emulator from the host machine through an interface.

Emulator debugger: M3T-PD30 (V.3.00 Release 1 or later) Host machine: IBM PC/AT or compatible OS: Windows 95 or Windows NT 4.0 CPU: 486DX4-100 MHz or Pentium 75 MHz (or faster recommended) Memory: 16 MB or more

Target MCU

This means the microcomputer you are going to debug.

Target system

This means a user's application system using the microcomputer to be debugged.

Things to Check When Unpacking

The M306V0T-RPD-E consists of the following parts and manuals. When unpacking, check to see if your M306V0T-RPD-E package contains all of these items.

M306V0T-RPD-E (Emulation pod)	1
FLX120-RPD (Flexible cable for connecting PC4701 emulator)	
Screws for connecting PC4701 emulator	2
FLX100 (Flexible cable for connecting target system, already connected)	1
FLX-100LCC (Converter board for 100LCC package)	1
OSC-2 (Oscillator board)	1
M306V0T-RPD-E English user's manual (this manual)	1
M306V0T-RPD-E Japanese user's manual	1

If any of these items are missing or found faulty, please contact your local distributor. Also, if there is any question or doubt about the packaged products, contact your local distributor.

CAUTION

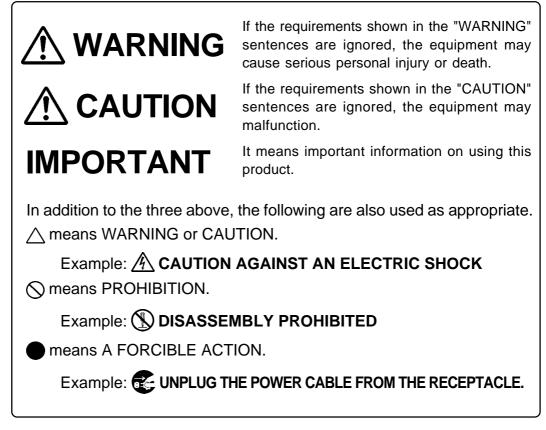
Please keep the M306V0T-RPD-E's packing box and cushion material in your place for reuse at a later time when sending your product for repair or other purposes. Always use these packing box and cushion material when transporting the M306V0T-RPD-E.

Chapter 1. Precautions for Safety

In both the user's manual and on the product itself, several icons are used to insure proper handling of this product and also to prevent injuries to you or other persons, or damage to your properties.

This chapter describes the precautions which should be taken in order to use this product safely and properly. Be sure to read this chapter before using this product.

1.1 Safety Symbols and Meanings



The following pages describe the symbols "WARNING", "CAUTION", and "IMPORTANT".

1.2 Precautions for Safety

Warning for Installation:



• Do not set this product in water or areas of high humidity. Spilling water or some other liquid into the main unit can cause an unrepairable damage.

Warning for Use Environment:

• This equipment is to be used in an environment with a maximum ambient temperature of 35°C. Care should be taken that this temperature is not exceeded.

Cautions to Be Taken for This Product:

- Do not disassemble or modify this product as personal. Disassembling or modifying this product can cause damage.
- Use caution when handling the main unit. Be careful not to apply a mechanical shock.
- Do not touch directly the connector pins of the emulator main unit or the target MCU connector pins with your hand.
- Do not pull the emulation pod main unit by the FLX120-RPD flexible cable or the FLX100 flexible cable for connecting the target system.
- The flexible cables FLX120-RPD and FLX100 are different from earlier models. The slits make them more flexible. However, excessive flexing or force may break conductors.
- Do not use inch-size screws for this equipment. The screws used in this equipment are all ISO (meter-size) type screws. When replacing screws, use same type screws as used on the equipment.

Cautions for Installation:



• Do not place the main unit on its side when in use.

Notes on PC4701 Emulators:

• The PC4700H emulators whose serial number ends with a number cannot be used with M306V0T-RPD-E. Use only products whose serial number ends with a letter of the alphabet. The serial number is on the bottom of the PC4700H.

Example: 5KE100 <u>Can NOT be used</u> with M306V0T-RPD-E. Requires an upgrade.

Example: 5LE123B Can be used with M306V0T-RPD-E.

• Do not turn off the power when downloading firmware. If the emulator is powered off in the middle of the process, it will become unable to start up normally. In cases when the power is inadvertently shut off, re-execute downloading.

Notes on Abnormal Operation:

• If the PC4701 system does not pass all self-checks (excluding when an target system error occurs), there is the possibility of trouble in the system. In such case, contact the place of purchase.

Please take note that self-check should be executed under the following conditions.

- (1) The target system is not connected.
- (2) The Switch SW6 is set to 'L' position, SW7 to '16' (see Chapter 4).
- If the emulator malfunctions due to external interference or some other causes, follow the steps given below.
 - (1) Press the system reset switch located on the front panel of the emulator.
 - (2) If the emulator does not return to the normal operation despite the step (1) above, turn off the power source of the emulator, turn it on again.

Notes on Target System:

- Because the emulation pod does not have the capacity to supply power to other devices, design your system so that the emulator MCU is powered by the target system.
- Make sure that the target's supply voltage is within the MCU specification and in the range of +4.5 to 5.5 V.
- Do not change power supply voltage of the target system after activating the power.
- Before turning on power to anything, check the host machine, emulator main unit, emulation pod, conversion board and user's target system are properly connected. Activate power to units as explained here following.
 - (1) Turn on and off power to the target system, and then the PC4701 continuously.
 - (2) After turning on power to the PC4701, check the Target Status LEDs on the emulator' front panel to see if the M306V0T-RPD-E is ready to operate.
 - Is the power supplied? Check that Target Status LED (POWER) is on.
 - Is the reset released? Check that Target Status LED (RESET) is off.

(10/48)

Notes on Connecting Target System:

- When connecting the FLX100 flexible cable and the converter board, be careful not to forcibly press the connector top of the converter board. (The flexible cable and the converter board are guaranteed for only 20 insertion/removal iterations.)
- Especially be careful not to insert the converter board in the wrong direction.

Note on Reset Input from Target System:

• The reset input from the target system is accepted only during program execution (while the RUN signal lamp on the PC4701 is lit).

Note on HOLD Input from Target System:

• Input an 'L' level signal into the HOLD pin only during program execution. Doing so while the program is stopped or during run time debugging may cause the emulator to malfunction.

Note on Address 0 Access:

• With M16C/6V group MCUs, when a maskable interrupt is generated, the interrupt data (interrupt number and interrupt request level) stored in address 0 is read out.

Also, the interrupt request bit is cleared when address 0 is read out. Consequently, when the address 0 readout instruction is executed or when address 0 is read out in the cause of a program runaway, a malfunction occurs in that the interrupt is not executed despite the interrupt request, because the request bit of the highest priority interrupt factor enabled is cleared.

Therefore, with M306V0T-RPD-E, if address 0 is read out for anything other than interrupt processing, the yellow LED lights up as a warning. When this LED lights up, there is the possibility of illegal access to address 0, therefore check the program. This LED is extinguished from the emulator reset switch.

Notes on Differences between Actual MCU and Emulator:

- Emulator operation differs from mask MCU operation, as listed below:
 - (1) Reset condition
 - (2) Initial values of internal resource data at power-on
 - (3) Internal RAM and ROM capacities, etc.
 - (4) Ports PO₀ to P57

Of the M306V0T-RPD-E's I/O ports, ports $PO_0 - P5_7$ are connected to the user's target system through the port emulation circuit inside M306V0T-RPD-E.

Table 1.1 gives the device which uses these ports.

Port	I/O device
P00-P57	M60074-0111FP

(5) Writing into pullup control registers 0 and 1 (addresses 03FC₁₆ and 03FD₁₆ respectively)

To write into pullup control registers 0 and 1 (addresses $03FC_{16}$ and $03FD_{16}$ respectively), it is necessary to write the word data from address $03FC_{16}$. This is an M306V0T-RPD-E restriction.

(6) Ports P50 - P53

To enable pullup when setting bit 2 (PUR12) of the pullup register 1 to '1' in single chip mode, be sure to set the bit 2 (PM02) and bit 7 (PM07) of the processor mode register 0 to '0'. This is an M306V0T-RPD-E restriction.

(7) BCLK output disable

To disable the BCLK output, it is necessary to set the BCLK output disable bit (PM07) of processor mode register 0 (address 0004₁₆) to '1' and to <u>set bit 3 of the port P5 direction register</u> (address 03EB₁₆) to '0'. This is an M306V0T-RPD-E restriction.

(8) Hold control

When an 'L' level signal is input to the terminal HOLD and the terminal enters the hold state, in actuality, ports $P0_0$ to $P5_2$ enter the hold state one half cycle later than the MCU (see Chapter 7, Operation Timing).

(9) A/D converter

A/D converter characteristics differ from actual MCU characteristics because the flexible cable and other elements are used between the emulation MCU and user's target.

(10) Status while the program is stopped

In a system using the PC4701, the loop iteration at the address F8000₁₆ establishes and maintains the status during program stop. Also, when debug commands are issued to check or edit memory data, addresses F8000₁₆ to F83FF₁₆ and addresses F6000₁₆ to F63FF₁₆ are used as work area. For this reason, when the CS0 output is enabled in the microprocessor mode, the CS0 signal is output.

(12/48)

(11) Actual MCU output and emulator output

Table 1.2 Actual MCU and emulator outputs

Access area	Access area Signal Actual MCU M306V0T-RPD-E		Item with differen outputs	
SFR area	Address	Output	Output	
	Data	Output (Floating during	Floating	*
		read operations)		*
	RD/WR	Output (WR=Low at write cycle,	No output	.1.
		RD=Low at read cycle)	(High output fixed)	*
	CS	No output	No output	
		(High output fixed)	(High output fixed)	
	ALE	No output	Output	
		(Low output fixed)		*
	BHE	Output	Output	
Internal RAM area	Address	Previous status maintained	Output	*
Internal ROM area	Data	Floating	Floating	
	RD/WR	No output	No output	
		(High output fixed)	(High output fixed)	
	CS	No output	No output	
		(High output fixed)	(High output fixed)	
	ALE	No output	Output	
		(Low output fixed)		*
	BHE	No output (Previous	Output	
		status maintained)		*
External area	Address	Output	Output	
	Data	Output (Inputs external	Output (Inputs external	
		data when reading)	data when reading)	
	RD/WR	Output (WR=Low at write cycle,	Output (WR=Low at write cycle,	
		RD=Low at read cycle)	RD=Low at read cycle)	
	CS	Output	Output	
	ALE	Output	Output	
	BHE	Output	Output	
In STOP state	Address		Output	
	Data		Floating	
	RD/WR		Output only for Read operations	
			(WR = High output fixed)	
	CS		Output	
	ALE		Output	
	BHE		Output	

(13/48)

IMPORTANT Notes on MAP Settings and References: • For details on MAP settings and references, refer to the M3T-PD30 emulator debugger user's manual. • Always set the SFR area to EXTERNAL. • Set the OSD RAM area to INTERNAL. • This pod uses the 4 bytes from 0FFFC₁₆ to 0FFFF₁₆ as a stack area for a RESET command. The RESET command cannot be correctly executed when these 4 bytes cannot be read or written to. You must therefore take care using the MAP resetting procedure when the following condition (1) or condition (2) are true. (1) When the 4 bytes from 0FFFC₁₆ to 0FFFF₁₆ are set to EXTERNAL in a system shifting from single chip mode to memory expansion mode or microprocessor mode (2) When the 4 bytes from 0FFFC16 to 0FFFF16 are set to EXTERNAL in a system started in microprocessor mode and there is no read/write-enabled memory in the external area. Use the following MAP setting procedure when either of the above conditions (1) or (2) are true. (1) Set the 4 bytes from bytes from 0FFFC₁₆ to 0FFFF₁₆ to INTERNAL. (2) Execute the M3T-PD30 emulator debugger RESET command. (3) Set the stack pointer. (Example) RESET: FCLR I LDC #480H, SP <- stack pointer setting (STOP the program after executing this command.) (4) Set the 4 bytes from 0FFFC16 to 0FFFF16 to EXTERNAL. Note on Changing Data in OSD RAM Area When Program is not Executed: • To change data when a program is not executed, write data when the map setting is in both 'INTERNAL' and 'EXTERNAL'. Procedure (1) With 'INTERNAL' specified, change data in the OSD RAM area. Change data in the MEMORY WINDOW, Script Window, etc. (2) From the script window, change the map setting of the OSD RAM area to 'EXTERNAL'. MAP 400, FFF, EXT (3) With 'EXTERNAL' specified, change data in the OSD RAM area. Change data in the MEMORY WINDOW, Script Window, etc. (4) Change the map setting of the OSD RAM area to 'INTERNAL' again.

MAP 400,FFF,INT

(Example) When changing the data in the OSD RAM area (Address: 410h) to '55h'. set MemoryByte(MB) 410,55 MAP 400,FFF,EXT set MemoryByte(MB) 410,55 MAP 400,FFF,INT

(14/48)

Note on Reading MCU Internal Sources:

- When this product is configured with the emulator debugger, the following results occur when reading the registers listed in Table 1.3. Data is not displayed correctly, but internal data is not affected at all.
 - (1) Real-time tracing

Data values in the MCU internal source read cycle are not displayed correctly.

(2) Real-time RAM monitoring

Data is not displayed correctly.

This happens because data read from the MCU internal source is not output to an external point. When data is written into an MCU internal source, the data input from the external point is displayed correctly.

Table 1.3 Registers and signals

Desister	0: 1
Register	Signal
Processor mode registers 0, 1	PM0, PM1
System clock control registers 0, 1	CM0, CM1
Chip select control register	CSR
Address identity interrupt enable register	AIER
Protect register	PRCR
Supervisor timer start register	WDTS
Supervisor timer control register	WDC
Address identity interrupt registers 0, 1	RMAD0, RMAD1
DMA source pointers 0, 1	SAR0, SAR1
DMA destination pointers 0, 1	DAR0, DAR1
DMA transfer counters 0, 1	TCR0, TCR1
DMA control registers 0, 1	DM0CON, DM1CON

Note on Stack:

• This product uses up to 8 bytes for stack.

Chapter 2. Introduction

M306V0T-RPD-E is used by being connected to the PC4701 emulator main unit. Figure 2.1 shows the system configuration.

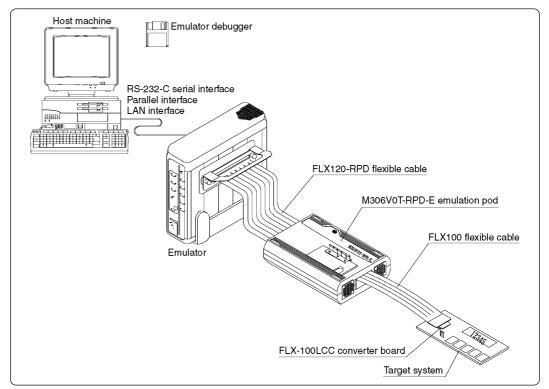


Figure 2.1 System configuration

Following products (1) to (4) are attached to M306V0T-RPD-E.

(1) Emulation pod (M306V0T-RPD-E)

This emulation pod contains emulation memory and debug functions.

(2) Flexible cable (FLX120-RPD)

This 120-pin flexible cable connects the PC4701 and the emulation pod.

(3) Flexible cable (FLX100)

This 100-pin flexible cable connects the emulation pod and the target system.

(4) Converter board (FLX-100LCC)

This board is connected to a socket for 100LCC on the target system.

(16/48)

Chapter 3. Specifications

Table 3.1 lists the specifications of the M306V0T-RPD-E.

Table 31	Specifications	of the	M306V0T PDD F
Tuble 5.1	specifications	0j ine	M306V0T-RPD-E

Item	Description
Usable emulator	PC4701HS, PC4701L
Usable MCU	M16C/6V Group MCUs
Usable MCU modes	(1) Single-chip mode(2) Memory expansion mode(3) Microprocessor mode
Evaluation MCU type	M306V0EEFP
Emulation pod clock	Main clock (Xin): 10.000 MHz Sub-clock (Xcin): 32.768 kHz
Max. operating frequency of emulation pod	10 MHz, 0-wait (Vcc = 5.0 V)
Power supply range	4.5 to 5.5 V
Emulation memory	1 MB
Stack capacity used for emulator	Up to 8 bytes
Suspended cycles in run-time debug	16-byte dump: About 312 BCLK cycle 16-byte fill: About 283 BCLK cycle
Power supply to pod	 Supplied from an emulator The operating voltage of the emulation pod is determined by detecting the supply voltage of the target system. When no target system is connected, or when the supply voltage of the target system is more than 5.0 V, the operating voltage is 5.0 V.
Connection with target system	100-pin LCC package: via FLX-100LCC
Operating temperature range	5 to 35°C (no dew)
Storage temperature range	-10 to 60°C
Overseas standards	• EMI standards (FCC part15 Class A) • CE marking (EN55022, EN50082-1)

Chapter 4. Settings for Target Systems

4.1 Positions of Switches

Figure 4.1 shows positions of switches on the M306V0T-RPD-E.

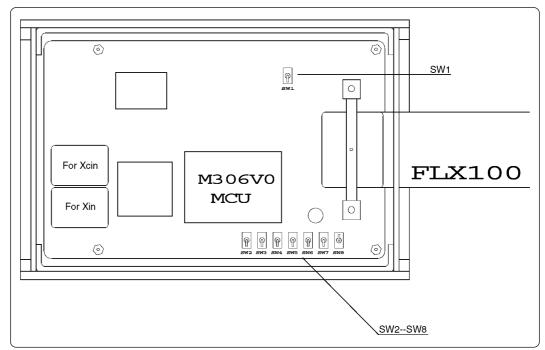


Figure 4.1 Positions of switches

4.2 Settings

Table 4.1 gives a list of switch settings.

Table 4.1 Switch (SW) settings

Signal	SW No.	Setting				
PORT/OSD (P57)	SW1	To use port P57 PORT OS (P57) PORT (Fortor, sotting)		To use OSD function PORT DOSD (P5) OSD		
P87/XCIN	SW2	(Factory-setting) To use port P87 P87 XCIN P87 (Factory-setting)		To use XCIN terminal P87 XCIN XCIN		
P86/XCOUT	SW3	To use port P8 ₆ P8 ₆ XCOUT P8 ₆ (Factory-setting)	To use port P86 To leave unconnected To use XCOUT P86 XCOUT P86 XCOUT P86 XCOUT P86 XCOUT XCOUT			
XOUT	SW4	To open OPEN XOUT OPEN (Factory-setting)		To connect XOUT terminal OPEN XOUT XOUT		
P5₅/ <u>HOLD</u> P57/RDY	SW5	With pullup resistor (HOLD/RDY) H GPEN H (Factory-setting)		Without pullup resistor H A XOUT OPEN		
CNVss	SW6	To pull down 33 kΩ L H (Factory-setting)	To leave ur	H	To pull up 33 kΩ L H H	
BYTE	SW7	To pull down 33 kΩ 16 16 (Factory-setting)	To leave ur 16	aconnected	To pull up 33 kΩ 16 8 8	
P70/71	SW8	With pullup resisto H _ OPE H			thout pullup resistor H _ OPEN OPEN (Factory-setting)	

* Leave the SW1 in the PORT position.

IMPORTANT

Note on Switch Settings:

• Be sure to turn off the power before setting the switches. Otherwise, the internal circuits may be damaged.

4.3 Procedure for Setting Oscillation Frequency

If you are using the emulation pod's internal oscillator, see (1) below. If you are using the target system's oscillator, see (2) on page 22.

(1) Using emulation pod's oscillator

M306V0T-RPD-E is available with two types of internal oscillator circuits:

- OSC-3 oscillator board (preinstalled in M306V0T-RPD-E): 10 MHz
- OSC-2 oscillator board (bare board)
- (a) OSC-3 oscillator board

M306V0T-RPD-E is equipped with a 10MHz internal oscillator board. If you are running M306V0T-RPD-E at 10 MHz, you can use the OSC-3 oscillator board shipped with.

(b) OSC-2 oscillator board

M306V0T-RPD-E is supplied with an oscillator circuit bare board (connector pin mounting).

If you are using M306V0T-RPD-E with internal oscillation frequencies other than those permitted by the standard OSC-3 oscillator board, create the desired oscillator circuit on the OSC-2 bare board and replace the OSC-3 board with the OSC-2 board.

Figure 4.2 shows the external dimensions and connector pin layout of the OSC-2 oscillator board. Figure 4.3 shows the OSC-2 circuit. Use the circuit constants recommended by the maker of the oscillator circuit.

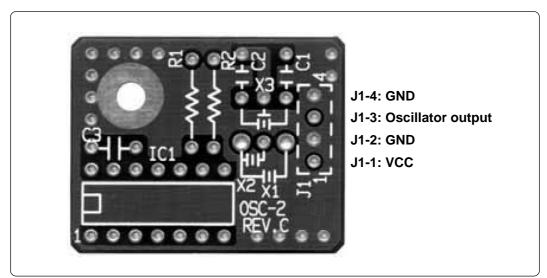


Figure 4.2 External view of oscillator bare board OSC-2 and connector pin assignments

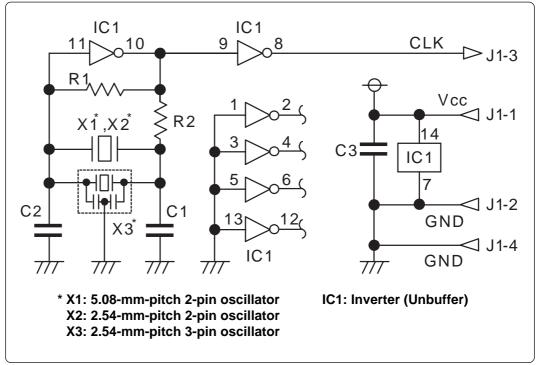


Figure 4.3 Circuit of oscillator board OSC-2

Figure 4.4 shows how to replace the oscillator board.

- (a) Remove the screw locking the oscillator board in place.
- (b) Lift the board directly up and out of the product.
- (c) Plug the J1 connector of the new oscillator board into the J7 connector on the M306V0T-RPD-E board.
- (d) Lock the board to the M306V0T-RPD-E board with the screw.

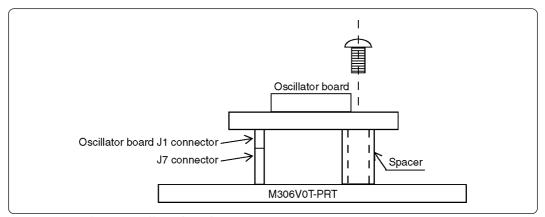


Figure 4.4 Replacing oscillator board

- (2) Using target system's oscillator
 - a. To operate the emulator with an external clock, construct the oscillation circuit shown in Figure 4.5 in the target system and input the oscillation output at 40-60% duty (within the operating range of the emulator's MCU) into the Xin (Xcin) pin.
 - b. Make note of the fact that in the oscillation circuit shown in Figure 4.6 where a resonator is connected between the Xin (Xcin) and Xout (Xcout) pins, oscillation does not occur because a flexible cable, buffer IC and other devices are used between the evaluation MCU and the target system.
 - c. Use the M3T-PD30 emulator debugger to set CLK to EXT. For details, see the M3T-PD30 emulator debugger user's manual.

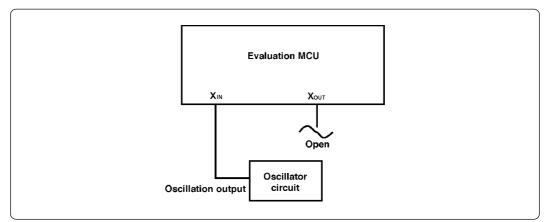


Figure 4.5 External oscillator circuit

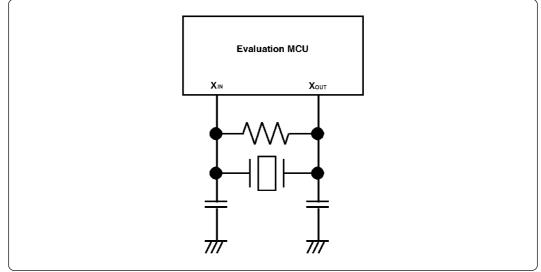


Figure 4.6 Circuit for no oscillation in this pod

4.4 Data Slicer I/O Signals and OSD Clock I/O Signal Circuits

Figure 4.7 shows the layout of the parts on the board and the circuit diagrams used for data slicing and the OSD clock circuits.

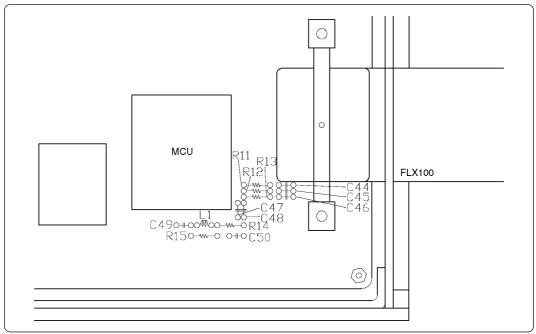


Figure 4.7 Layout of parts

(1) Figure 4.8 shows the part numbers and the constants of the parts of the signal CVIN.

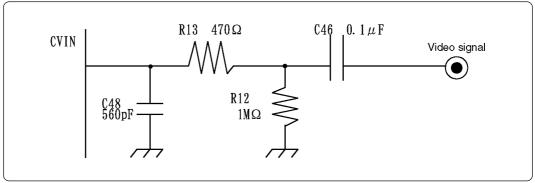


Figure 4.8 CVIN signal circuit

(2) Figure 4.9 shows the part numbers and the constants of the parts of the signal HLF.

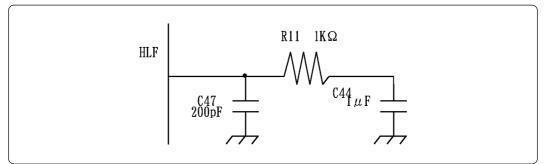


Figure 4.9 HLF signal circuit

(3) Figure 4.10 shows the part numbers and the constants of the parts of the signal VHOLD.

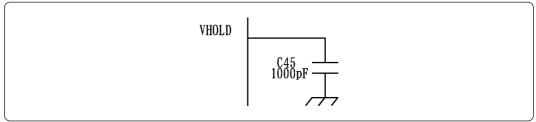


Figure 4.10 VHOLD signal circuit

(4) Figure 4.11 shows the part numbers and the constants of the parts of the signal OSC1, OSC2.

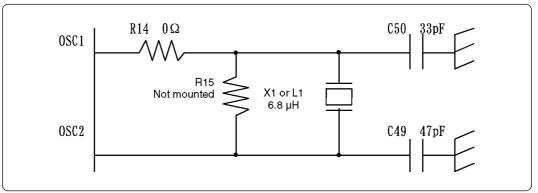


Figure 4.11 OSC1, OSC2 signal circuit

4.5 Procedure for Setting Switches

(1) You must remove the cover of the M306V0T-RPD-E in order to set the switches. To do so, remove the four screws holding the top cover. There are two screws on each side (see Figure 4.12). Be sure to turn OFF the power before attempting to change the switch settings. If the power is ON, you may damage the circuits.

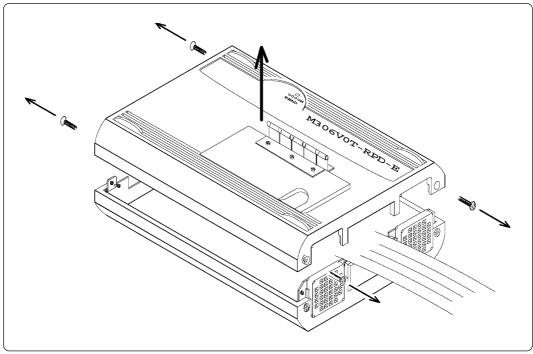


Figure 4.12 Removing M306V0T-RPD-E cover

(2) After removing the cover, set the switches referring to Table 4.1 (page 19).

- (3) After setting the switches, replace the cover by reversing the procedure for its removal.
 - 1. Replace the M306V0T-RPD-E cover.
 - 2. Replace the screws (two on each side) holding the M306V0T-RPD-E cover in place.

4.6 Procedure for Writing MCU File

You may need to change the contents of the MCU file, depending on the MCU being developed. The MCU file is in the same directory as the emulator debugger. The file name is M30620.MCU for the M16C/6V group MCUs.

The MCU file contains the following information: SFR area, internal RAM area, internal ROM area, and firmware filename. Set these according to the MCU being developed. Use your editor to edit the MCU file.

- 0 SFR area starting address
- 3FF SFR area ending address
- 2C00 Internal RAM starting address
- 3FFF Internal RAM ending address

F0000 Internal ROM starting address

FFFFFInternal ROM ending address

M30620B Firmware filename (Do not edit.)

(25/48)

Chapter 5. Method of Connection

5.1 Connecting Emulator Main Unit

Use the FLX120-RPD 120-pin flexible cable to connect the emulator main unit and M306V0T-RPD-E. Figure 5.1 shows how to connect the emulator main unit and FLX120-RPD.

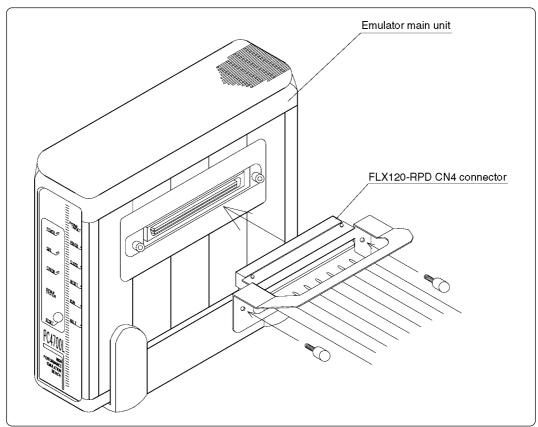
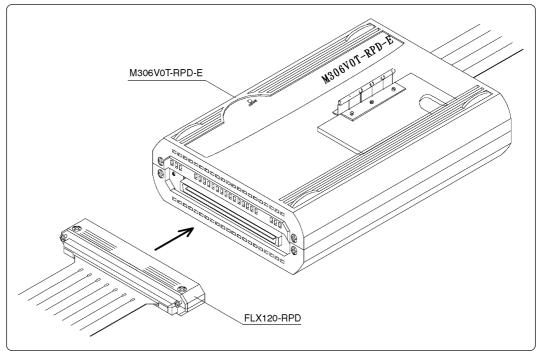


Figure 5.1 Connecting emulator main unit and FLX120-RPD



Connect FLX120-RPD with M306V0T-RPD-E. Figure 5.2 shows how to connect M306V0T-RPD-E and FLX120-RPD.

Figure 5.2 Connecting M306V0T-RPD-E and FLX120-RPD

Note on Connecting the Cable:

• Always shut OFF power before connecting the cable. The power ON state could destroy internal circuits.

5.2 Connecting Target System

Figure 5.3 shows connections between emulator probes and target systems. For more details, refer to "Renesas Tools - Accessory Guide".

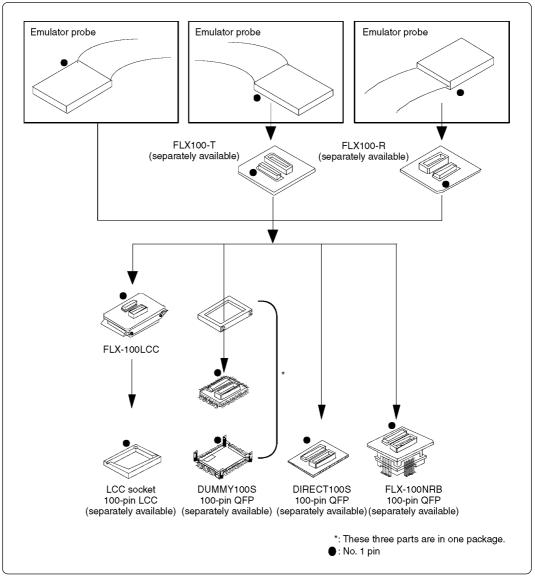


Figure 5.3 Connection to target systems

Notes on Connecting the Target Systems:

- Be sure to turn off the power before making connections. Otherwise, the internal circuits may be damaged.
- The small connectors of the FLX100 and FLX-100LCC are guaranteed for only 20 insertion/removal iterations.

Chapter 6. Constraints

(1) BRK instruction

The BRK instruction cannot be used.

- (2) Software and hardware breaks
 - a. Do not set simultaneous software and hardware breaks.
 - b. Do not use software breaks for areas for which the MAP setting is EXTERNAL.
- (3) Using multiplex bus with the PC4701L emulator

You can only use Fetch as a hardware break condition for the multiplex bus area.

- (4) Using address match interrupts
 - a. Do not set a software break at the same address as you have set an address match interrupt.
 - b. Do not set a hardware break within the 4 bytes leading up to the address at which an address match interrupt is invoked.
 - c. When the address at which an address match interrupt occurs is achieved by one-step execution, the address match interrupt processing and the first command on return from the interrupt are executed simultaneously.
- (5) Software resets

Do not use software resets.

(6) Watchdog function

If using the watchdog function, you can only use program execution. If you want to use debugger functions other than program execution, disable the watchdog function.

Chapter 7. Operation Timing (Memory Expansion and Microprocessor Modes)

7.1 Separate Bus (no wait)

Table 7.1 and Figure 7.1 show bus timing when using the memory expansion mode and microprocessor mode (separate bus, no wait).

Symbol	Parameter	M306V0EEFP [ns]		M306V0T-RPD-E [ns]	
		Min.	Max.	Min.	Max.
td(BCLK-AD)	Address output delay time	-	25	-	47
th(BCLK-AD)	Address output hold time (BCLK)	4	-	4	-
th(RD-AD)	Address output hold time (RD)	0	-	-5	-
th(WR-AD)	Address output hold time (WR)	0	-	-3	-
td(BCLK-CS)	Chip-select output delay time	-	25	-	36
th(BCLK-CS)	Chip-select output hold time (BCLK)	4	-	4	-
td(BCLK-ALE)	ALE signal output delay time	-	25	-	14
th(BCLK-ALE)	ALE signal output hold time	-4	-	-4	-
td(BCLK-RD)	RD signal output delay time	-	25	-	40
th(BCLK-RD)	RD signal output hold time	0	-	0	-
td(BCLK-WR)	WR signal output delay time	-	25	-	40
th(BCLK-WR)	WR signal output hold time	0	-	0	-
td(BCLK-DB)	Data output delay time (BCLK)	-	40	-	70
th(BCLK-DB)	Data output hold time (BCLK)	4	-	2	-
td(DB-WR)	Data output delay time (WR)	(Note 1)	-	(Note 2)	-
th(WR-DB)	Data output hold time (\overline{WR})	0	-	0	-

Table 7.1 Memory expansion mode and microprocessor mode (separate bus, no wait)

Note 1. Compute bus timing according to BCLK frequency. Use the below formula.

$$td(DB-WR) = \frac{10^9}{f(BCLK)x2} - 40 \text{ [ns]}$$

Note 2. Compute bus timing according to BCLK frequency. Use the below formula.

$$td(DB-WR) = \frac{10^9}{f(BCLK)x2} - 55 \text{ [ns]}$$

(30/48)

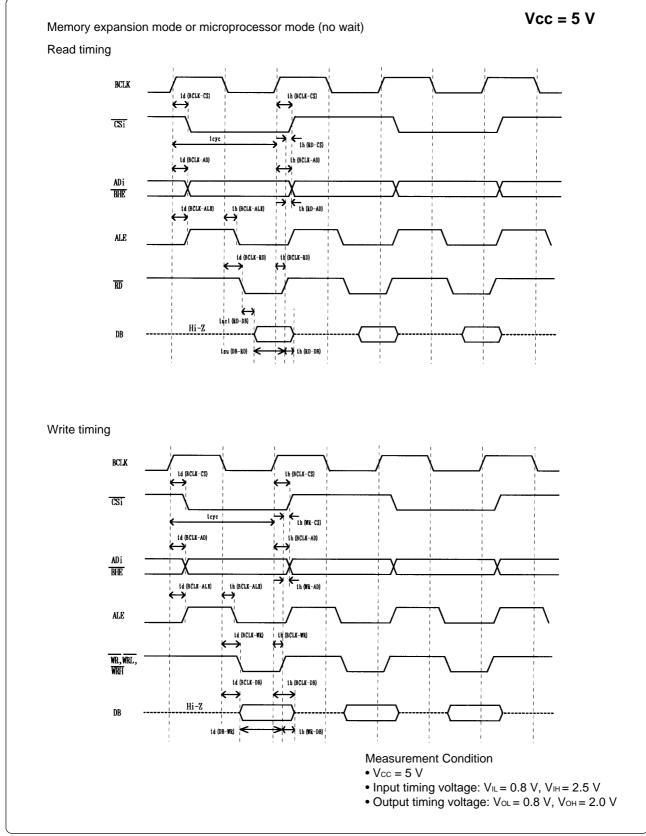


Figure 7.1 Memory expansion mode and microprocessor mode (separate bus, no wait)

(31/48)

7.2 Separate Bus (with wait), When Accessing to External Memory Area

Table 7.2 and Figure 7.2 show bus timing when using the memory expansion mode and microprocessor mode (with wait, when accessing to the external memory area).

Symbol	Parameter	M306V0EEFP [ns]		M306V0T-RPD-E [ns]	
		Min.	Max.	Min.	Max.
td(BCLK-AD)	Address output delay time	-	25	-	47
th(BCLK-AD)	Address output hold time (BCLK)	4	-	4	-
th(RD-AD)	Address output hold time (RD)	0	-	-5	-
th(WR-AD)	Address output hold time (WR)	0	-	-3	-
td(BCLK-CS)	Chip-select output delay time	-	25	-	36
th(BCLK-CS)	Chip-select output hold time (BCLK)	4	-	4	-
td(BCLK-ALE)	ALE signal output delay time	-	25	-	14
th(BCLK-ALE)	ALE signal output hold time	-4	-	-4	-
td(BCLK-RD)	RD signal output delay time	-	25	-	40
th(BCLK-RD)	RD signal output hold time	0	-	0	-
td(BCLK-WR)	WR signal output delay time	-	25	-	40
th(BCLK-WR)	WR signal output hold time	0	-	0	-
td(BCLK-DB)	Data output delay time (BCLK)	-	40	-	70
th(BCLK-DB)	Data output hold time (BCLK)	4	-	2	-
td(DB-WR)	Data output delay time (WR)	(Note 1)	-	(Note 2)	-
th(WR-DB)	Data output hold time (WR)	0	-	0	-

Table 7.2 Memory expansion mode and microprocessor mode (separate bus, with wait)

Note 1. Compute bus timing according to BCLK frequency. Use the below formula.

$$td(DB-WR) = \frac{10^9}{f(BCLK)x2} - 40 \text{ [ns]}$$

Note 2. Compute bus timing according to BCLK frequency. Use the below formula.

 $td(DB-WR) = \frac{10^9}{f(BCLK)x2} - 55 \text{ [ns]}$

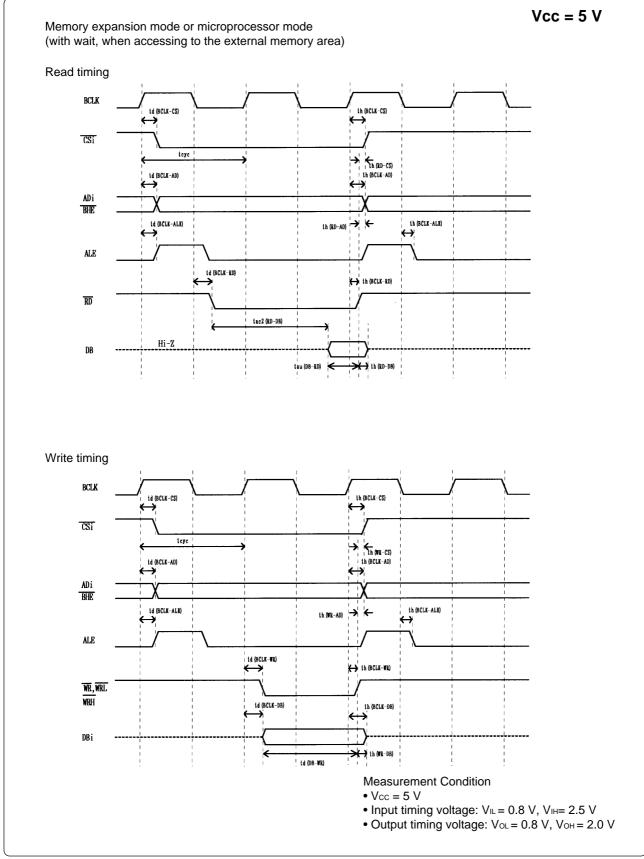


Figure 7.2 Memory expansion mode and microprocessor mode (separate bus, with wait)

7.3 Multiplex Bus (with wait), When Accessing to External Memory Area

Table 7.3 and Figure 7.3 show bus timing when using the memory expansion mode and microprocessor mode (with wait, when accessing to the external memory area).

Symbol	Parameter	M306V0EEFP [ns]		M306V0T-RPD-E [ns]	
		Min.	Max.	Min.	Max.
td(BCLK-AD)	Address output delay time	-	25	-	47
th(BCLK-AD)	Address output hold time (BCLK)	4	-	4	-
th(RD-AD)	Address output hold time (\overline{RD})	(Note 1)	-	(Note 2)	-
th(WR-AD)	Address output hold time (WR)	(Note 1)	-	(Note 2)	-
td(BCLK-CS)	Chip-select output delay time	-	25	-	36
th(BCLK-CS)	Chip-select output hold time (BCLK)	4	-	4	-
th(RD-CS)	Chip-select output hold time (RD)	(Note 1)	-	(Note 2)	-
th(WR-CS)	Chip-select output hold time (\overline{WR})	(Note 1)	-	(Note 2)	-
td(BCLK-RD)	RD signal output delay time	-	25	-	38
th(BCLK-RD)	RD signal output hold time	0	-	0	-
td(BCLK-WR)	WR signal output delay time	-	25	-	40
th(BCLK-WR)	WR signal output hold time	0	-	0	-
td(BCLK-DB)	Data output delay time (BCLK)	-	40	-	40
th(BCLK-DB)	Data output hold time (BCLK)	4	-	4	-
td(DB-WR)	Data output delay time (WR)	(Note 1)	-	(Note 2)	-
th(WR-DB)	Data output hold time (\overline{WR})	(Note 1)	-	(Note 2)	-
td(BCLK-ALE)	ALE signal output delay time (BCLK)	-	25	-	14
th(BCLK-ALE)	ALE signal output hold time (BCLK)	-4	-	-4	-
td(AD-ALE)	ALE signal output delay time (ADDRESS)	(Note 1)	-	(Note 2)	-
th(ALE-AD)	ALE signal output hold time (ADDRESS)	50	-	50	-
td(AD-RD)	ALE signal output hold time (ADDRESS)	0	-	0	-
td(AD-WR)	ALE signal output hold time (ADDRESS)	0	-	0	-
tdz(RD-AD)	ALE signal output hold time (ADDRESS)	-	8	-	13

 Table 7.3 Memory expansion mode and microprocessor mode (multiplex bus, with wait)

(34/48)

Note 1. Compute bus timing according to BCLK frequency. Use the below formula.

$$th(RD-AD) = \frac{10^9}{f(BCLK)x2} \qquad [ns] \qquad td(DB-WR) = \frac{10^9x3}{f(BCLK)x2} - 40 \qquad [ns]$$

$$th(RW-AD) = \frac{10^9}{f(BCLK)x2} \qquad [ns] \qquad th(WR-DB) = \frac{10^9}{f(BCLK)x2} \qquad [ns]$$

$$th(RD-CS) = \frac{10^9}{f(BCLK)x2} \qquad [ns] \qquad td(DB-WR) = \frac{10^9}{f(BCLK)x2} - 25 \qquad [ns]$$

$$th(WR-CS) = \frac{10^9}{f(BCLK)x2} \qquad [ns]$$

Note 2. Compute bus timing according to BCLK frequency. Use the below formula.

$$th(RD-AD) = \frac{10^9}{f(BCLK)x2} - 10 \text{ [ns]} td(DB-WR) = \frac{10^9x3}{f(BCLK)x2} - 24 \text{ [ns]}$$

$$th(RW-AD) = \frac{10^9}{f(BCLK)x2} - 10 \text{ [ns]} th(WR-DB) = \frac{10^9}{f(BCLK)x2} - 35 \text{ [ns]}$$

$$th(RD-CS) = \frac{10^9}{f(BCLK)x2} - 12 \text{ [ns]} td(DB-WR) = \frac{10^9}{f(BCLK)x2} - 35 \text{ [ns]}$$

$$th(WR-CS) = \frac{10^9}{f(BCLK)x2} - 12 \text{ [ns]} td(DB-WR) = \frac{10^9}{f(BCLK)x2} - 35 \text{ [ns]}$$

(35/48)

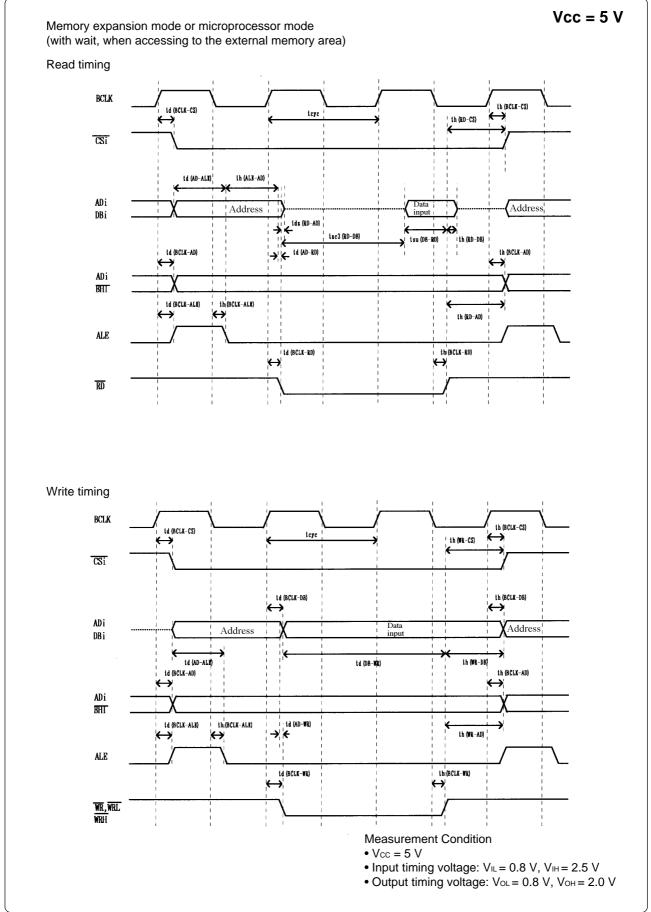


Figure 7.3 Memory expansion mode and microprocessor mode (multiplex bus, with wait)

(36/48)

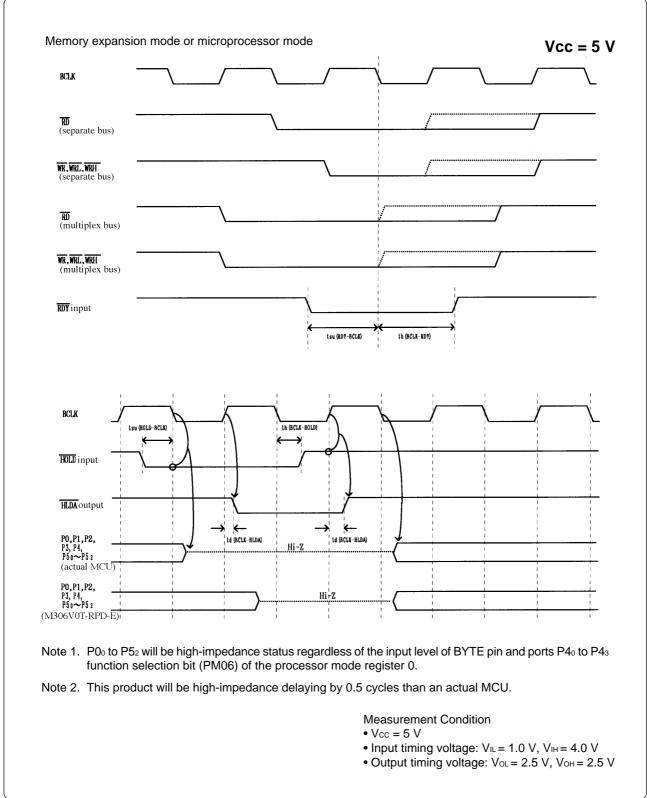
7.4 Timing Requirements

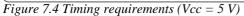
Table 7.4 and Figure 7.4 show timing requirements when using the memory expansion mode and microprocessor mode.

Table 7.4 Timing requirements (Vcc = 5 V)

Symbol	Parameter	M306V0EEFP [ns]		M306V0T-RPD-E [ns]	
		Min.	Max.	Min.	Max.
tsu(DB-RD)	Data input setup time	40	-	80	-
tsu(RDY-BCLK)	RDY input setup time	30	-	50	-
tsu(HOLD-BCLK)	HOLD input setup time	40	-	(Note 1)	-
th(RD-DB)	Data input hold time	0	-	0	-
th(BCLK-RDY)	RDY input hold time	0	-	0	-
th(BCLK-HOLD)	HOLD input hold time	0	-	0	-
th(BCLK-HLDA)	HLDA output delay time	-	40	-	40

Note 1. tsu(HOLD-BCLK) = $\frac{10^9 x_3}{f(BCLK)x_2}$ + 20





Chapter 8. Electrical Characteristics

Tables 8.1 and 8.2 show IC electrical characteristics of user's interface.

Symbol	Parameter		Standard value			Unit
		Vcc	Min.	Тур.	Max.	
Vінс	'H' level control input voltage	2.0 4.5	1.5 3.15	-	-	V
Vilc	'L' level control input voltage	2.0 4.5	-	-	0.5 1.35	V
Ron	On resistance	2.0 4.5	-	2000 100	- 200	Ω
∆Rом	On resistance difference between arbitrary 2 switches in a package	2.0 4.5	-	50 3	-	Ω
loff	Switch input/output off leakage current	- 6.0	-	-	- ±	μΑ

Table 8.1 Electrical characteristics of 74HC4066FS (P00 - P52)

Table 8.2 Electrical characteristics of M60	0074-0111FP (P53 - P57, 5V)
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Symbol	Parameter	St	Unit		
		Min.	Тур.	Max.	
Vт- Vт+ Vтн	Input voltage	1.25 2.3 0.3	- -	2.3 3.7 1.2	V
Vон	'H' level output voltage	4.95	-	-	V
Vol	'L' level output voltage	-	-	0.05	V
Іон	'H' level output current	-	-	-8	mA
lol	'L' level output current	8	-	-	mA
Ін	'H' level input current	-1	-	+1	μΑ
١L	'L' level input current	-1	-	+1	μΑ
Іоzн	Off state 'H' level output current	-1	-	+1	μΑ
loz∟	Off state 'L' level output current	-1	-	+1	μΑ
Сю	Input/output terminal capacity	-	7	15	pF

Chapter 9. Maintenance and Guarantee

9.1 Maintenance

If dust or dirt collects on any equipment of your emulation system, wipe it off with a dry soft cloth. Do not use thinner or other solvents because these chemicals can cause the equipment's surface coating to separate.

9.2 Guarantee

If your product becomes faulty within one year after its purchase while being used under good conditions by observing "Precautions for Safety" described in Chapter 1 of this user's manual, we will repair or replace your faulty product free of charge. Note, however, that if your product's fault is raised by any one of the following causes, we will repair it or replace it with new one with extra-charge:

- Misuse, abuse, or use under extraordinary conditions
- Unauthorized repair, remodeling, maintenance, and so on
- Inadequate user's system or misuse of it
- · Fires, earthquakes, and other unexpected disasters

In the above cases, contact your local distributor. If your product is being leased, consult the leasing company or the owner.

9.3 Repair Provisions

(1) Repair with extra-charge

The products elapsed more than one year after purchase can be repaired with extra-charge.

(2) Replacement with extra-charge

If your product's fault falls in any of the following categories, the fault will be corrected by replacing the entire product instead of repair, or you will be advised to purchase new one, depending on the severity of the fault.

- · Faulty or broken mechanical portions
- Flaw, separation, or rust in coated or plated portions
- · Flaw or cracks in plastic portions
- Faults or breakage caused by improper use or unauthorized repair or modification
- Heavily damaged electric circuits due to overvoltage, overcurrent or shorting of power supply
- Cracks in the printed circuit board or burnt-down patterns
- Wide range of faults that makes replacement less expensive than repair
- Unlocatable or unidentified faults
- (3) Expiration of the repair period

When a period of one year elapses after the model was dropped from production, repairing products of the model may become impossible.

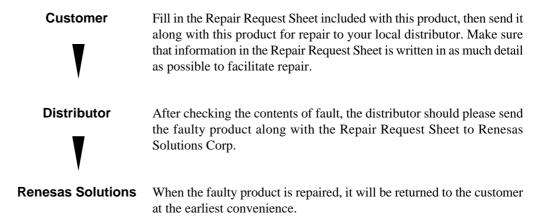
(4) Transportation fees at sending your product for repair

Please send your product to us for repair at your expense.

(40/48)

9.4 How to Request for Repair

If your product is found faulty, follow the procedure below to send your product for repair.



Note on Transporting the Product:



• When sending your product for repair, use the packing box and cushion material supplied with this product when delivered to you and specify handling caution for it to be handled as precision equipment. If packing of your product is not complete, it may be damaged during transportation. When you pack your product in a bag, make sure to use conductive polyvinyl supplied with this product (usually a blue bag). When you use other bags, they may cause a trouble on your product because of static electricity.

Chapter 10. Troubleshooting

10.1 When M306V0T-RPD-E Does Not Work Properly

(1) Emulator main unit cannot be powered up.

- □ Check to see if the AC power cord is firmly plugged into the receptacle.
- □ Check to see if the AC power 3P-2P converting connector is firmly connected.
- (2) The M306V0T-RPD-E does not start up when the target system is connected with the PC4701 system. (The Error LED of the emulator main unit lights up.)
 - \Box Check (1) described above.
 - □ Check whether the emulator main unit and the FLX120-RPD are firmly connected.
 - □ Check whether the FLX120-RPD and the M306V0T-RPD-E are firmly connected.
 - □ Check whether the M306V0T-RPD-E and the target system are firmly connected.
 - □ Check whether the power and GND are supplied to the target system.
 - □ Check whether switches of the M306V0T-RPD-E are firmly set. (Refer to Chapter 4. for setting switches.)
 - \Box Check whether the RESET pin and NMI pin are held 'HIGH' when the target system is connected.
 - □ Check whether the HOLD pin and RDY pin are held 'HIGH' when in the microprocessor or memory expansion mode.
 - □ Check whether the oscillator circuit of the target system is oscillating correctly when using a target's oscillator.
 - □ Check whether correct firmware is downloaded in the emulator main unit. (Refer to the user's manual of the emulator debugger about how to download firmware.)
- (3) If the PC4701 system does not pass all self-checks (excluding when an target system error occurs), there is the possibility of trouble in the system. In such case, contact the place of purchase.

Please take note that self-check should be executed under the following conditions.

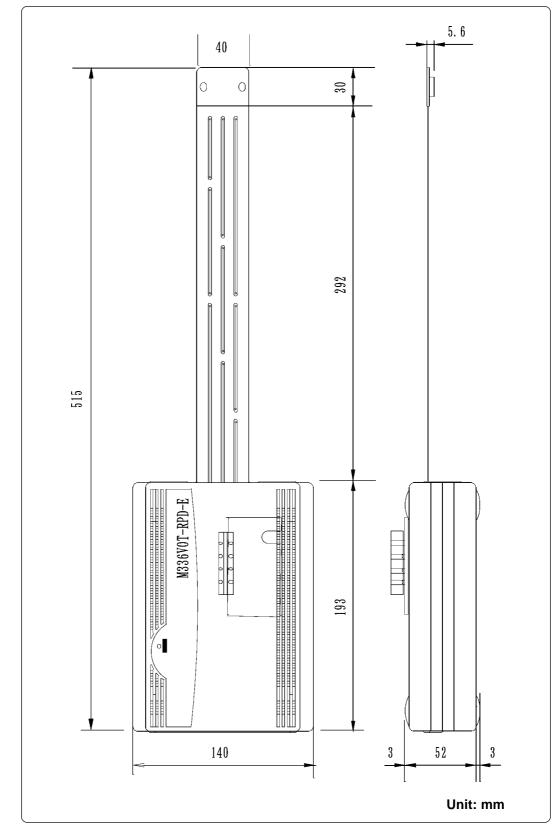
- The target system is not connected.
- The Switch SW6 is set to 'L' position, SW7 to '16' (See Chapter 4).

When the condition does not improve even if you check the items above, troubles described below are considered.

- Trouble of the evaluation MCU
- Trouble of the M306V0T-RPD-E
- Trouble of the PC4701 emulator main unit

(42/48)

Appendix A. External Dimensions



A.1 External Dimensions of the M306V0T-RPD-E

Figure A.1 External dimensions of the M306V0T-RPD-E

(43/48)

A.2 External Dimensions of the FLX-100LCC

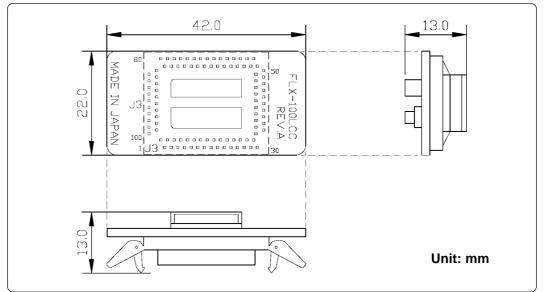


Figure A.2 External dimensions of the FLX-100LCC

(44/48)

Appendix B. Connection Diagrams

Figures B.1 and B.2 show the connection diagrams of the M306V0T-RPD-E. These connection diagrams mainly show the interface section with a target system, and the circuits which are not connected to the target system such as the emulator's control system are omitted.

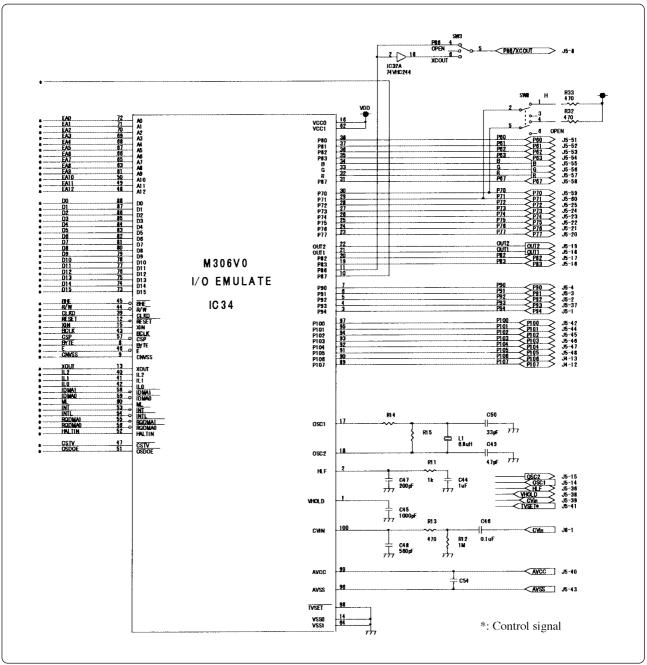


Figure B.1 Connection diagram of the M306V0T-RPD-E (1/2)

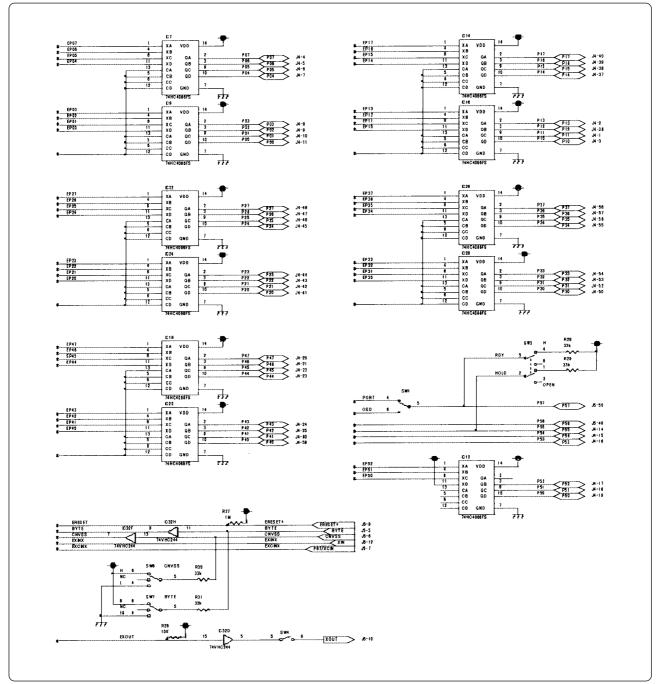


Figure B.2 Connection diagram of the M306V0T-RPD-E (2/2)

M306V0T-RPD-E User's Manual

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